

SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

N-Channel Silicon MOSFET

WPH4003 — General-Purpose Switching Device Applications

Features

- ON-resistance RDS (on) = 8.2Ω (typ.)
- Input Capacitance Ciss=850pF (typ.)
- 10V drive

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		1700	V
Gate-to-Source Voltage	VGSS		±30	V
5	I _{Dc} *1	Limited only maximum temperature Tch=150°C	3	Α
Drain Current (DC)	I _{Dpack} *2	Tc=25°C (SANYO's ideal heat dissipation condition) *3	2.5	Α
Drain Current (Pulse)	I _{DP}	PW≤10μs, duty cycle≤1%	6	Α
Allowable Power Dissipation	D-		3.0	W
	PD	Tc=25°C	55	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *4	EAS		49	mJ
Avalanche Current *5	IAV		3	Α

Note:*1 Shows chip capability

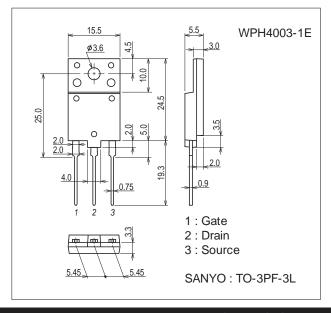
- *2 Package limited
- *3 SANYO's condition is radiation from backside.

The method is applying silicone grease to the backside of the device and attaching the device to water-cooled radiator made of aluminium.

- *4 VDD=50V, L=10mH, IAV=3A (Fig.1)
- *5 L≤10mH, single pulse

Package Dimensions

unit : mm (typ) 7538A-002



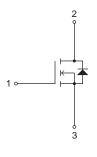
Product & Package Information

Package : TO-3PF-3LJEITA, JEDEC : SC-96

• Minimum Packing Quantity: 30 pcs./magazine

Marking Electrical Connection





Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
Parameter Syn		Conditions	min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=10mA, VGS=0V	1700			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =1360V, V _{GS} =0V			1	mA
Gate-to-Source Leakage Current	IGSS	V _{GS} =±30V, V _{DS} =0V			±100	nA
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	2		4	V
Forward Transfer Admittance	yfs	V _{DS} =20V, I _D =1.5A	1.2	2.4		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)	I _D =1.5A, V _G S=10V		8.2	10.5	Ω
Input Capacitance	Ciss			850		pF
Output Capacitance	Coss	V _{DS} =30V, f=1MHz		90		pF
Reverse Transfer Capacitance	Crss			27		pF
Turn-ON Delay Time	t _d (on)			19		ns
Rise Time	tr	0 5: 0		21		ns
Turn-OFF Delay Time	t _d (off)	See Fig.2		200		ns
Fall Time	tf			55		ns
Total Gate Charge	Qg			48		nC
Gate-to-Source Charge	Qgs	V _{DS} =200V, V _{GS} =10V, I _D =3A		6		nC
Gate-to-Drain "Miller" Charge	Qgd	1		22		nC
Diode Forward Voltage	V _{SD}	I _S =3A, V _{GS} =0V		0.8	1.5	V
Reverse Recovery Time	t _{rr}	See Fig.3		410		ns
Reverse Recovery Charge	Q _{rr}	IS=3A, VGS=0V, di/dt=100A/μs		3000		nC

Fig.1 Unclamped Inductive Switching Test Circuit

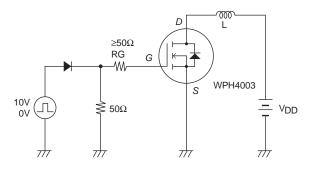


Fig.2 Switching Time Test Circuit

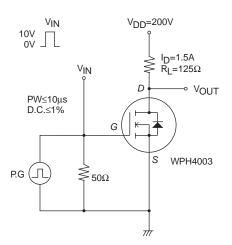
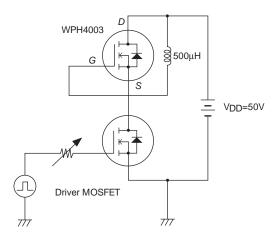
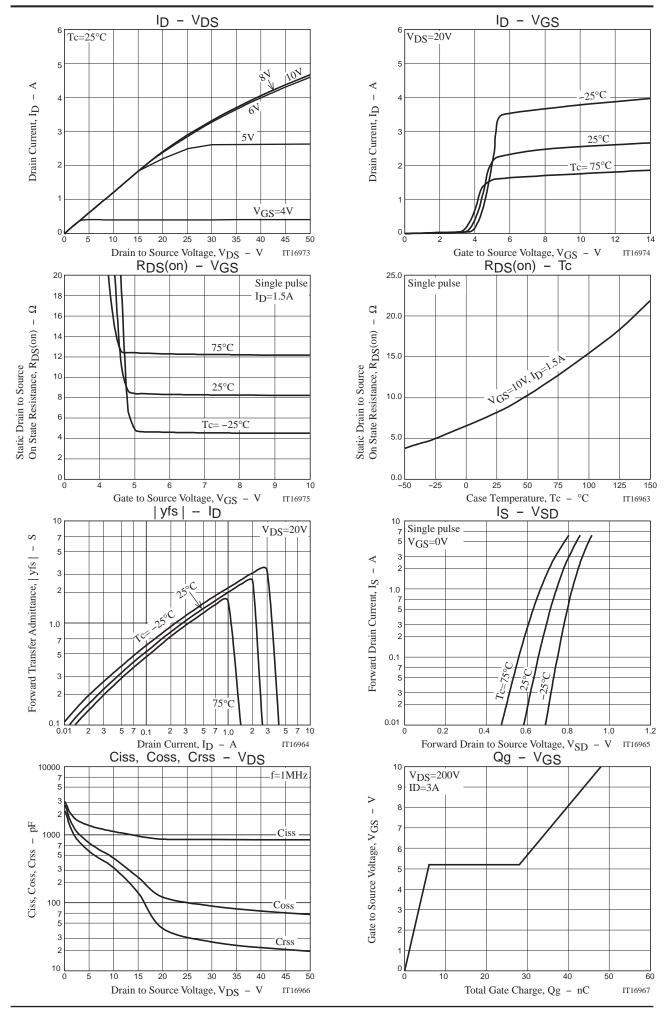


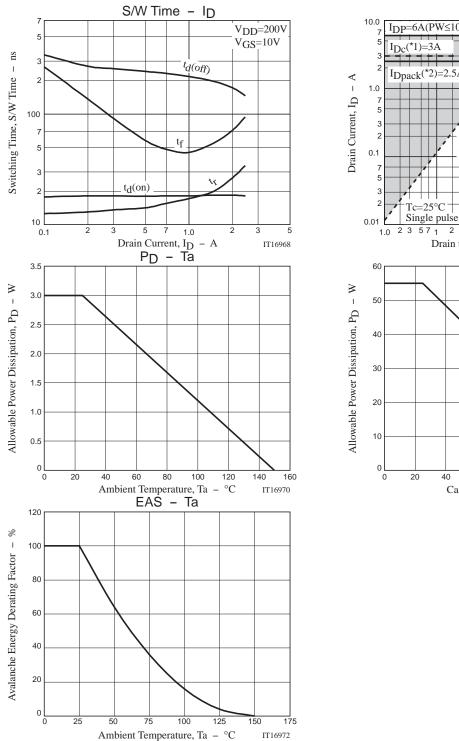
Fig.3 Reverse Recovery Time Test Circuit

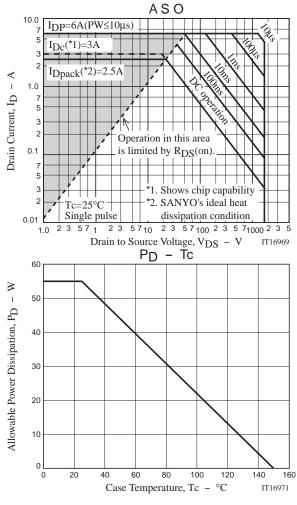


Ordering Information

Device	Package	Shipping	memo	
WPH4003-1E	TO-3PF-3L	30pcs./magazine	Pb Free	





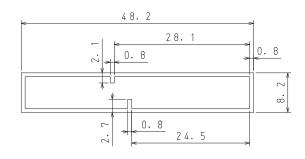


Magazine Specification

WPH4003-1E

1. Packing Format

Package Name	Maximum Number of devices contained (pcs)			Packing format		
I donago iyamo	Magazine	Inner box	Outer box	Inner BOX	Outer BOX	
TO-3PF-3L	30	360	1440	SPD-0V0001 12 magazines contained Dimensions:mm(external) 568×150×55	SPD-LV0010 4 inner boxes contained Dimensions:mm (external) 590x225x178	



Tolerance=±0.2mm
Thickness=0.8±0.2mm
Length =508.0±1mm
Material =PVC or PET
(Antistatic treatment)

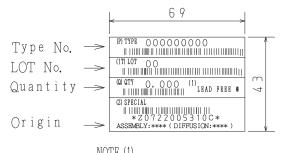
3. Storage method to magazine

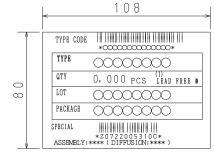


4. Inner box label (unit:mm)



It is a label at the time of factory shipments. The form of a label may change in physical distribution process.



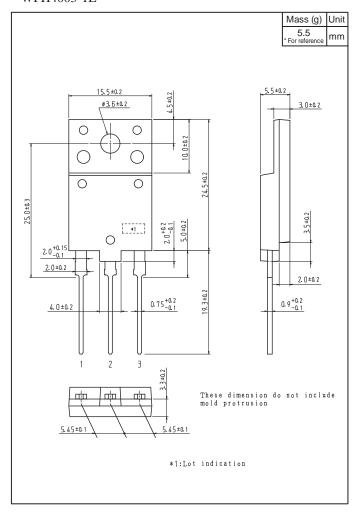


The LEAD FREE * description shows that the surface treatment of the terminal is lead free.

Label		JEITA Phase
LEAD FREE	3	JEITA Phase 3A

Outline Drawing

WPH4003-1E



Note on usage: Since the WPH4003 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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